P-Channel 1.8-V (G-S) MOSFET
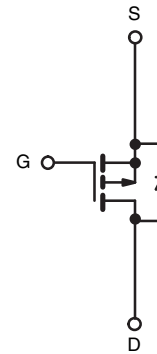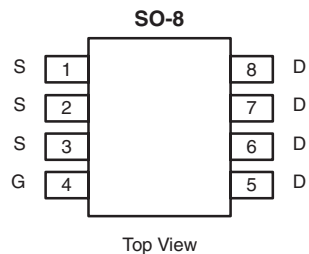
PRODUCT SUMMARY

V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)[b]	Q_g (Typ.)
- 8	0.009 at V_{GS} = - 4.5 V	- 13.7	55 nC
	0.011 at V_{GS} = - 2.5 V	- 12.4	
	0.016 at V_{GS} = - 1.8 V	- 10	

FEATURES

- **Halogen-free According to IEC 61249-2-21 Available**
- TrenchFET® Power MOSFET
- 1.8 V Rated
- 100 % R_g Tested

RoHS COMPLIANT

HALOGEN FREE Available

SO-8

Top View

Ordering Information: Si4465ADY-T1-E3 (Lead (Pb)-free)
Si4465ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	- 8	V
Gate-Source Voltage		V_{GS}	± 8	
Continuous Drain Current (T_J = 150 °C)[a, b]	T_A = 25 °C	I_D	- 13.7	A
	T_A = 70 °C		- 11	
	T_C = 25 °C		- 20	
	T_C = 70 °C		- 16	
Pulsed Drain Current		I_{DM}	- 40	
Continuous Source Current (Diode Conduction)[a, b]		I_S	- 2.5	
		I_{SM}	40	
Maximum Power Dissipation[a, b]	T_A = 25 °C	P_D	3.0	W
	T_A = 70 °C		1.95	
	T_C = 25 °C		6.5	
	T_C = 70 °C		4.2	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient (MOSFET)[a]	t ≤ 10 s	R_{thJA}	34	41	°C/W
	Steady State		67	80	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	15	19	

Notes:
a. Surface Mounted on 1" x 1" FR4 board.
b. t ≤ 10 s.

SPECIFICATIONS T_J = 25 °C, unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, I_D = - 250 μA	- 0.45		- 1.0	V
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 8 V			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = - 8 V, V_{GS} = 0 V			- 1	μA
		V_{DS} = - 8 V, V_{GS} = 0 V, T_J = 55 °C			- 5	
On-State Drain Current[a]	$I_{D(on)}$	$V_{DS} \geq - 5$ V, V_{GS} = - 4.5 V	- 20			A
Drain-Source On-State Resistance[a]	$R_{DS(on)}$	V_{GS} = - 4.5 V, I_D = - 14 A		0.0075	0.009	Ω
		V_{GS} = - 2.5 V, I_D = - 12 A		0.0092	0.011	
		V_{GS} = 1.8 V, I_D = 10 A		0.013	0.016	
Forward Transconductance[a]	g_{fs}	V_{DS} = - 10 V, I_D = - 14 A		58		S
Diode Forward Voltage[a]	V_{SD}	I_S = - 2.1 A, V_{GS} = 0 V		- 0.57	- 1.2	V
Dynamic[b]						
Total Gate Charge	Q_g	V_{DS} = - 4 V, V_{GS} = - 4.5 V, I_D = - 14 A		55	85	nC
Gate-Source Charge	Q_{gs}			6		
Gate-Drain Charge	Q_{gd}			10		
Gate Resistance	R_g			2.5	3.8	Ω
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = - 4 V, R_L = 4 Ω $I_D \cong$ - 10 A, V_{GEN} = - 4.5 V, R_g = 6 Ω		33	50	ns
Rise Time	t_r			170	255	
Turn-Off Delay Time	$t_{d(off)}$			168	255	
Fall Time	t_f			112	170	
Source-Drain Reverse Recovery Time	t_{rr}	I_F = - 2.1 A, dI/dt = 100 A/μs		85	130	
Body Diode Reverse Recovery Charge	Q_{rr}			81	125	nC

Notes:
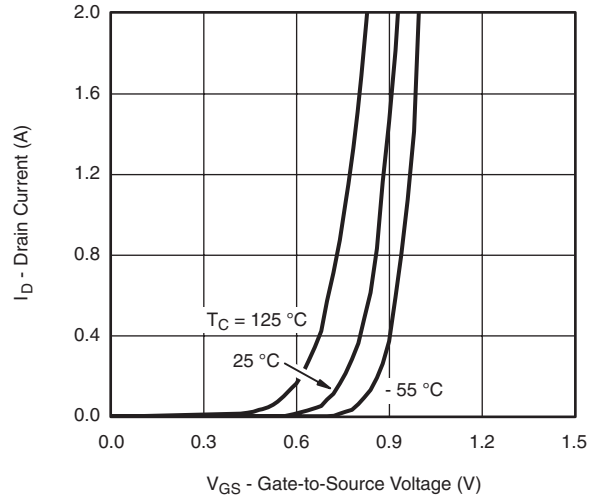a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
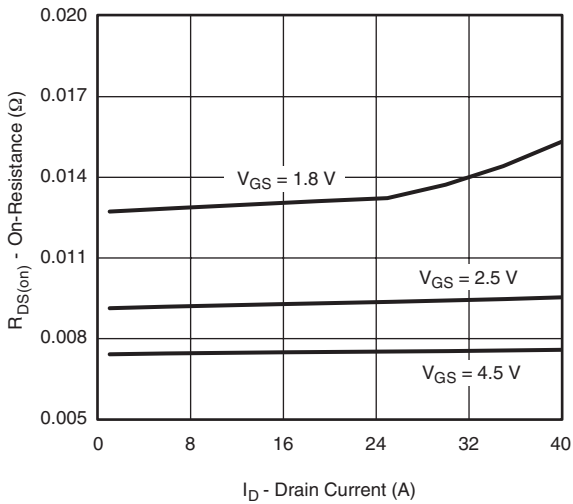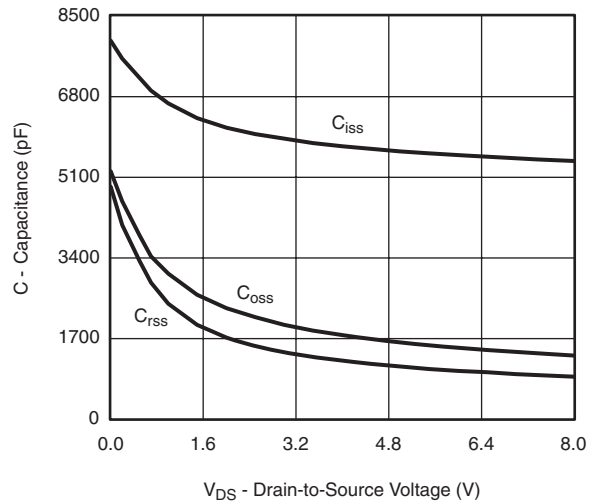
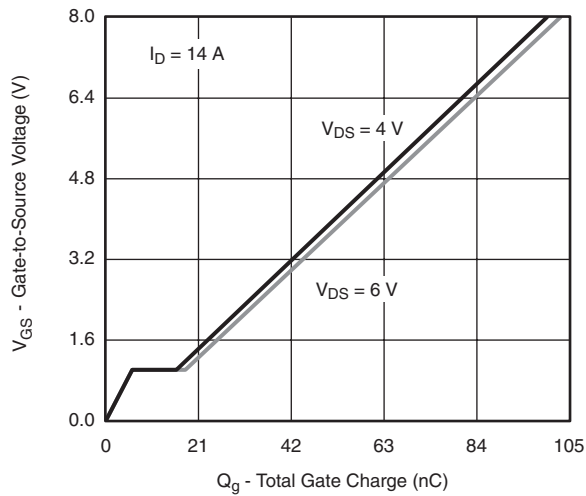## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted
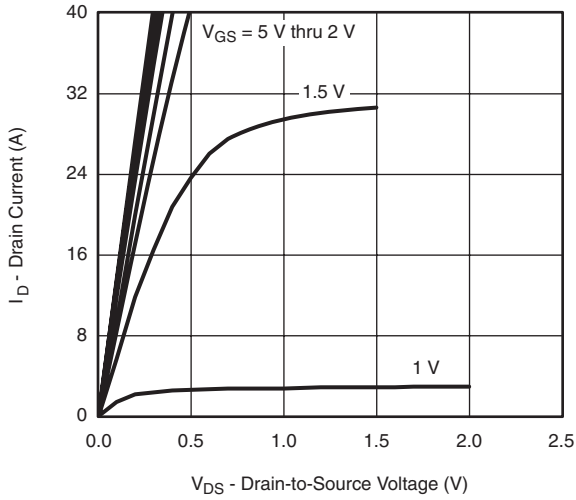
Output Characteristics

V_GS = 5 thru 2 V, 1.5 V, 1 V (axes: I_D - Drain Current (A) vs V_DS - Drain-to-Source Voltage (V))

Transfer Characteristics

T_C = 125 °C, 25 °C, - 55 °C (axes: I_D - Drain Current (A) vs V_GS - Gate-to-Source Voltage (V))

On-Resistance vs. Drain Current

V_GS = 1.8 V, V_GS = 2.5 V, V_GS = 4.5 V (axes: R_DS(on) - On-Resistance (Ω) vs I_D - Drain Current (A))

Capacitance

C_iss, C_oss, C_rss (axes: C - Capacitance (pF) vs V_DS - Drain-to-Source Voltage (V))

Gate Charge

I_D = 14 A, V_DS = 4 V, V_DS = 6 V (axes: V_GS - Gate-to-Source Voltage (V) vs Q_g - Total Gate Charge (nC))
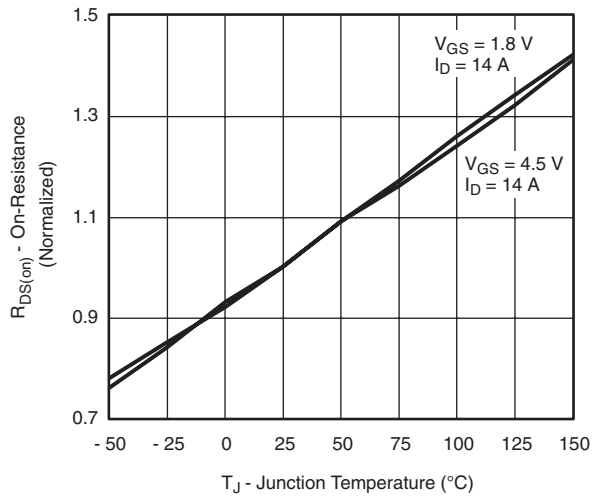
On-Resistance vs. Junction Temperature

V_GS = 1.8 V I_D = 14 A, V_GS = 4.5 V I_D = 14 A (axes: R_DS(on) - On-Resistance (Normalized) vs T_J - Junction Temperature (°C))
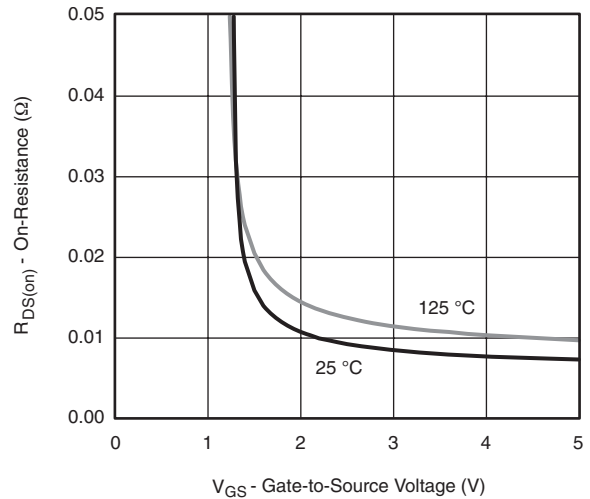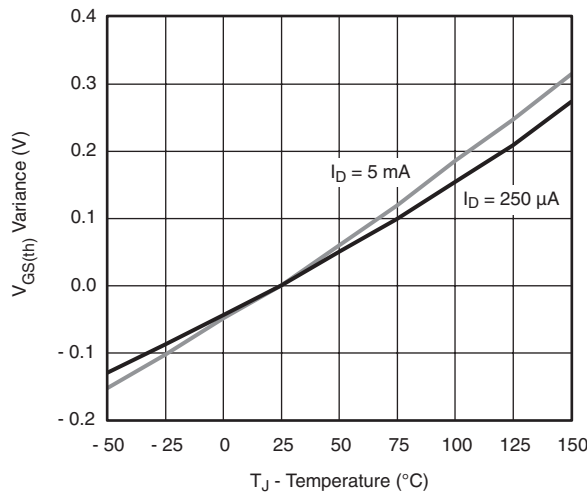
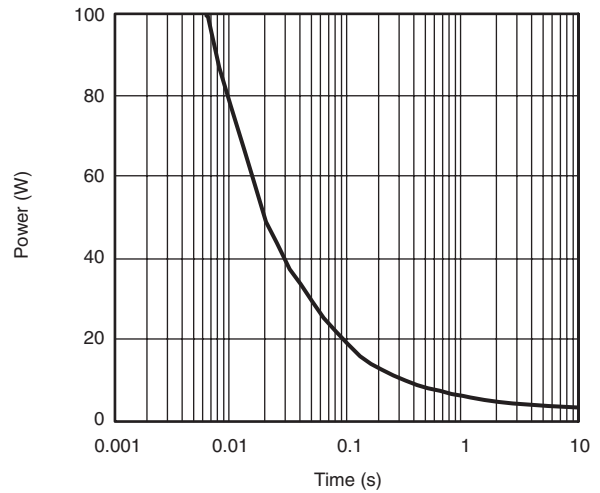## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted
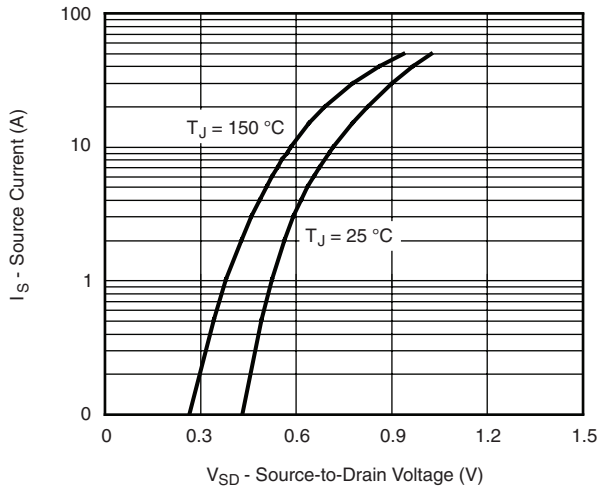
Source-Drain Diode Forward Voltage

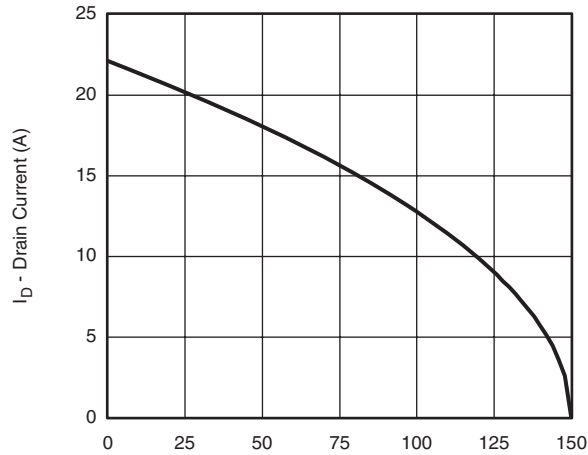**On-Resistance vs. Gate-to-Source Voltage**

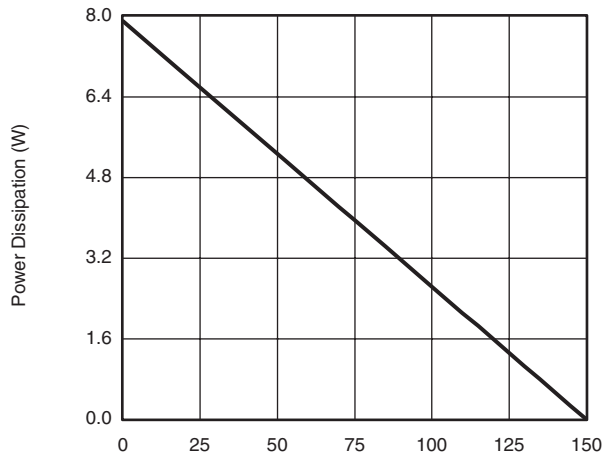**Threshold Voltage**

Single Pulse Power, Junction-to-Ambient
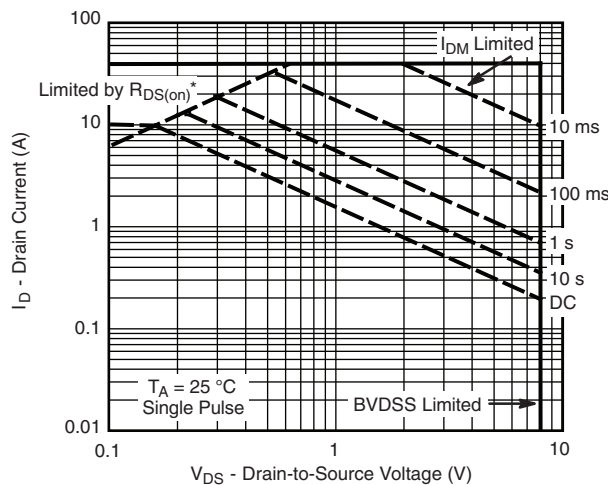
Safe Operatin Area

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Current Derating

Power, Junction-to-Foot
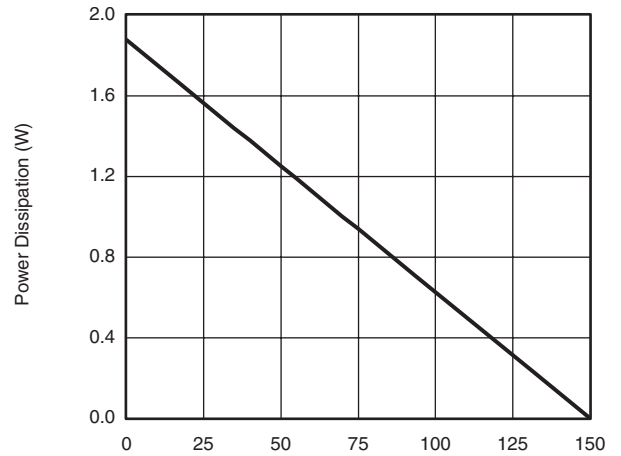
Power, Junction-to-Ambient

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Ambient

Normalized Thermal Transient Impedance, Junction-to-Foot
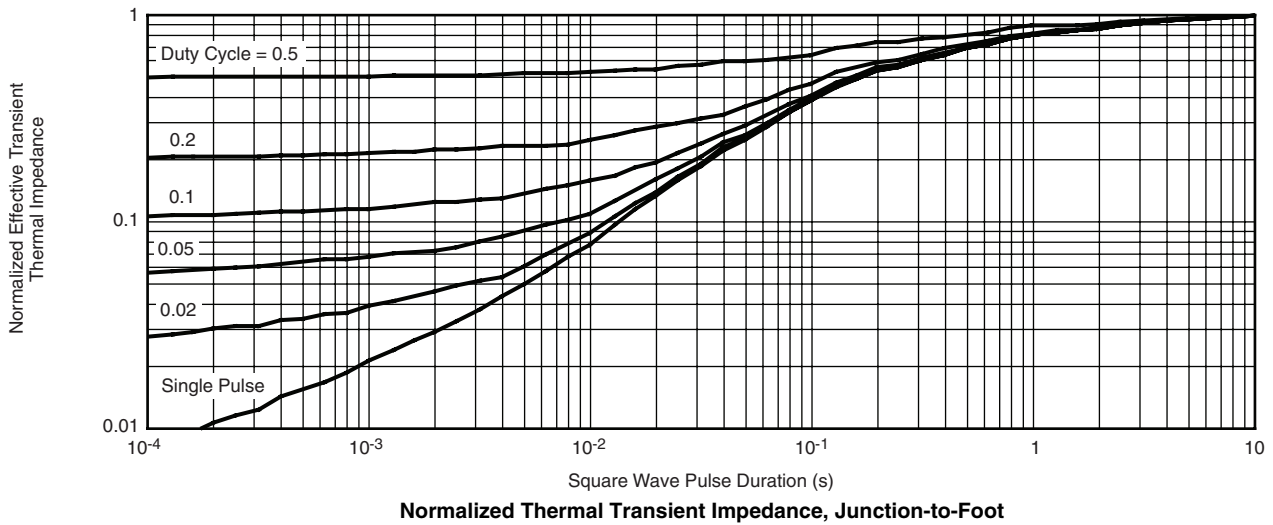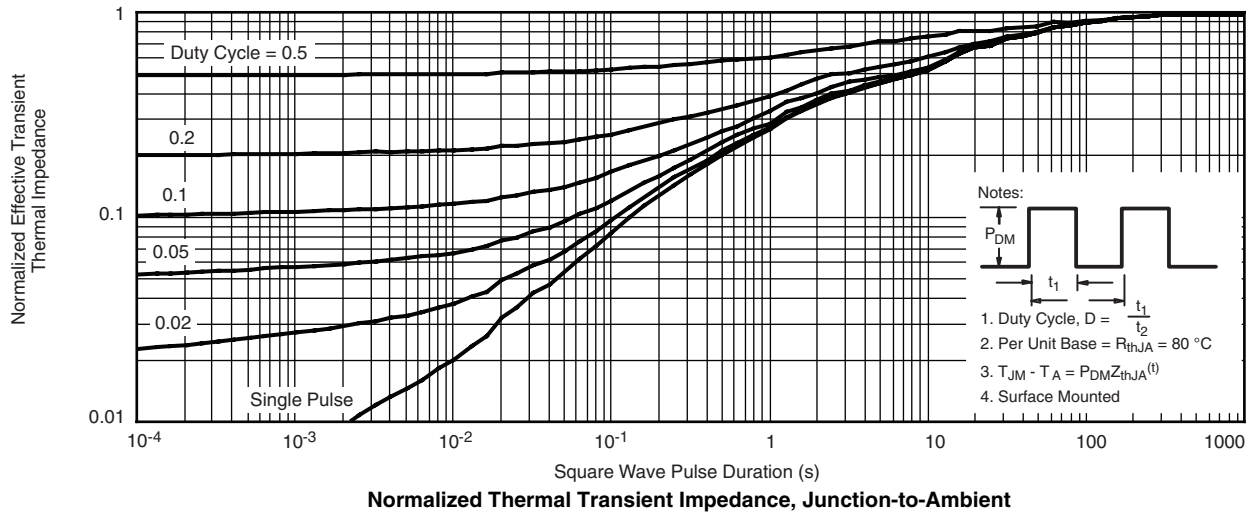
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SOIC (NARROW): 8-LEAD
JEDEC Part Number: MS-012

DIM	MILLIMETERS		INCHES	
	Min	**Max**	**Min**	**Max**
A	1.35	1.75	0.053	0.069
A_1	0.10	0.20	0.004	0.008
B	0.35	0.51	0.014	0.020
C	0.19	0.25	0.0075	0.010
D	4.80	5.00	0.189	0.196
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.020
L	0.50	0.93	0.020	0.037
q	0°	8°	0°	8°
S	0.44	0.64	0.018	0.026
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498				

RECOMMENDED MINIMUM PADS FOR SO-8

0.172
(4.369)

0.028
(0.711)

0.246
(6.248)

0.152
(3.861)

0.047
(1.194)

0.022
(0.559)

0.050
(1.270)

Recommended Minimum Pads
Dimensions in Inches/(mm)

Return to Index

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